# 2SA1617

## Silicon PNP Epitaxial

# **HITACHI**

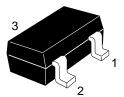
ADE-208-1022A (Z) 2nd. Edition Mar. 2001

#### Application

High voltage amplifier

#### Outline

**MPAK** 



- 1. Emitter
- 2. Base
- 3. Collector



## 2SA1617

#### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{\text{CBO}}$	<b>–</b> 55	V
Collector to emitter voltage	$V_{\text{CEO}}$	<b>–</b> 50	V
Emitter to base voltage	$V_{EBO}$	<b>–</b> 5	V
Collector current	I <sub>c</sub>	-100	mA
Collector power dissipation	P <sub>c</sub>	150	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

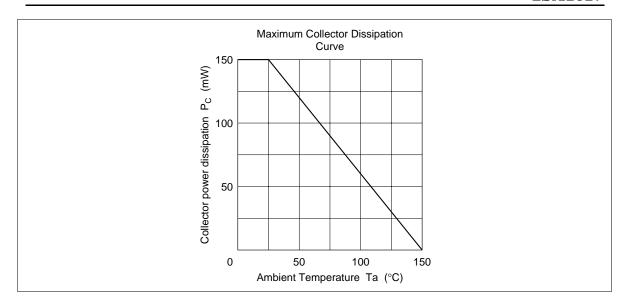
## Electrical Characteristics ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	<b>-</b> 55	_	_	V	$I_{c} = -10 \ \mu\text{A}, \ I_{e} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	<b>-</b> 50	_	_	V	$I_{C} = -1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	<b>-</b> 5	_	_	V	$I_E = -10 \ \mu A, \ I_C = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	-0.5	μΑ	$V_{CB} = -30 \text{ V}, I_{E} = 0$
Emitter cutoff current	I <sub>EBO</sub>	_	_	-0.5	μΑ	$V_{EB} = -2 \text{ V}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub> *1	100	_	320		$V_{CE} = -12 \text{ V}, I_{C} = -2 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-0.2	V	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -1 \text{ mA}$
Base to emitter voltage	$V_{BE}$	_	_	-0.8	V	$V_{CE} = -12 \text{ V}, I_{C} = -2 \text{ mA}$

Note: 1. The 2SA1617 is grouped by  $h_{\text{FE}}$  as follows.

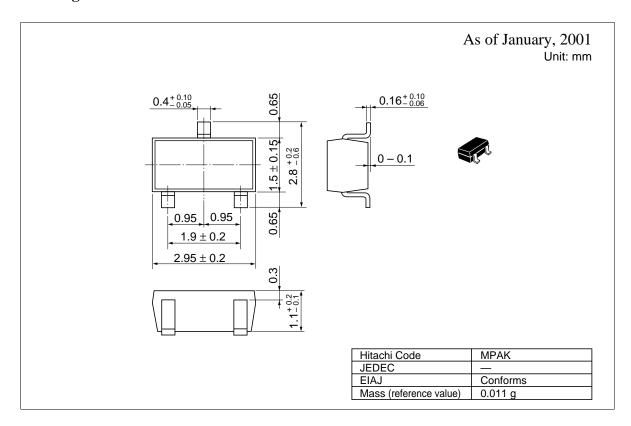
Grade	В	С
Mark	VIB	VIC
h <sub>FE</sub>	100 to 200	160 to 320

See charcteristic curves of 2SA1052



## 2SA1617

#### **Package Dimensions**



#### **Cautions**

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